



# DCR1110F52

# **Phase Control Thyristor**

DS5965-3 August 2014 (LN31843)

## **FEATURES**

- Double Side Cooling
- High Surge Capability

### **APPLICATIONS**

- High Power Drives
- High Voltage Power Supplies
- Static Switches

### **VOLTAGE RATINGS**

Part and Ordering Number	Repetitive Peak Voltages V <sub>DRM</sub> and V <sub>RRM</sub> V	$T_{vj} = -40^{\circ}\text{C to } 125^{\circ}\text{C},$ $I_{DRM} = I_{RRM} = 100\text{mA},$ $V_{DRM}, V_{RRM} t_p = 10\text{ms},$			
DCR1110F52* DCR1110F50	5200 5000	$I_{DRM} = I_{RRM} = 100 \text{mA},$			

Lower voltage grades available. \*5000V @ -40°C, 5200V @ 0°C

## **ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

## DCR1110F52

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

### **KEY PARAMETERS**

 $\begin{array}{lll} V_{DRM} & 5200V \\ I_{T(AV)} & 1107A \\ I_{TSM} & 14800A \\ dV/dt^* & 1500V/\mu s \\ dI/dt & 800A/\mu s \\ \end{array}$ 

\* Higher dV/dt selections available

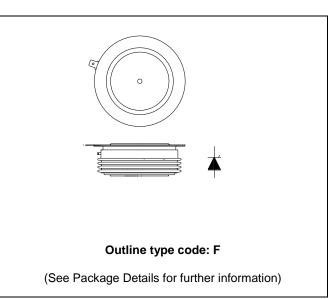


Fig. 1 Package outline





# **CURRENT RATINGS**

## $T_{case} = 60$ °C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Si	de Cooled			
I <sub>T(AV)</sub>	Mean on-state current	Half wave resistive load		А
I <sub>T(RMS)</sub>	RMS value	-		А
I <sub>T</sub>	Continuous (direct) on-state current	-	1684	А

# **SURGE RATINGS**

Symbol	Parameter	Test Conditions	Max.	Units
I <sub>TSM</sub>	Surge (non-repetitive) on-state current	10ms half sine, T <sub>case</sub> = 125°C	14.8	kA
l <sup>2</sup> t	I <sup>2</sup> t for fusing	$V_R = 0$	1.097	MA <sup>2</sup> s

# THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions			Max.	Units
R <sub>th(j-c)</sub>	Thermal resistance – junction to case	Double side cooled DC		-	0.0184	°C/W
		Single side cooled	Anode DC	-	0.0333	°C/W
			Cathode DC	-	0.0418	°C/W
R <sub>th(c-h)</sub>	Thermal resistance – case to heatsink	Clamping force 23kN Double side		-	0.004	°C/W
		(with mounting compound)	Single side	-	0.008	°C/W
$T_{vj}$	Virtual junction temperature	Blocking V <sub>DRM</sub> / <sub>VRRM</sub>		-	125	°C
T <sub>stg</sub>	Storage temperature range			-55	125	°C
F <sub>m</sub>	Clamping force			20.0	25.0	kN





# **DYNAMIC CHARACTERISTICS**

Symbol	Parameter	Test Condition	Min.	Max.	Units	
I <sub>RRM</sub> /I <sub>DRM</sub>	Peak reverse and off-state current	At V <sub>RRM</sub> /V <sub>DRM</sub> , T <sub>case</sub> = 125°C		-	100	mA
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V <sub>DRM</sub> , T <sub>j</sub> = 125°C, ga	ate open	-	1500	V/µs
dl/dt	Rate of rise of on-state current	From 67% V <sub>DRM</sub> to 2x I <sub>T(AV)</sub>	Repetitive 50Hz	-	200	A/µs
		Gate source 30V, 10Ω,	Non-repetitive	-	800	A/µs
		$t_r < 0.5 \mu s, T_j = 125 ^{\circ} C$				
V <sub>T(TO)</sub>	Threshold voltage – Low level	300A to 750A at T <sub>case</sub> = 125°	°C	-	0.948	V
	Threshold voltage – High level	750A to 4000A at T <sub>case</sub> = 125°C		-	1.078	V
r <sub>T</sub>	On-state slope resistance – Low level	300A to 750A at T <sub>case</sub> = 125°C		-	0.783	mΩ
	On-state slope resistance – High level	750A to 4000A at T <sub>case</sub> = 125°C		-	0.610	mΩ
t <sub>gd</sub>	Delay time	$V_D$ = 67% $V_{DRM}$ , gate source 30V, 10Ω $t_r$ = 0.5μs, $T_j$ = 25°C		-	3	μs
tq	Turn-off time	$T_j = 125$ °C, $V_R = 100$ V, $dI/dt = 5$ A/µs,		-	1000	μs
		dV <sub>DR</sub> /dt = 20V/μs linear to 2000V				
Qs	Stored charge	$I_T = 1000A$ , $tp = 1000us$ , $T_j = 125$ °C, $dI/dt = 5A/\mu s$ ,		2200	3800	μC
I <sub>RR</sub>	Reverse recovery current			90	115	Α
lι	Latching current	$T_j = 25^{\circ}C, V_D = 5V$		-	3	Α
lн	Holding current	$T_j = 25^{\circ}\text{C}, \ R_{G-K} = \infty, \ I_{TM} = 50$	$T_j = 25$ °C, $R_{G-K} = \infty$ , $I_{TM} = 500$ A, $I_T = 5$ A		300	mA



## **GATE TRIGGER CHARACTERISTICS AND RATINGS**

Symbol	Parameter	Test Conditions	Max.	Units
$V_{GT}$	Gate trigger voltage	$V_{DRM} = 5V$ , $T_{case} = 25$ °C	1.5	V
$V_{GD}$	Gate non-trigger voltage	At 50% V <sub>DRM</sub> , T <sub>case</sub> = 125°C	0.4	V
I <sub>GT</sub>	Gate trigger current	$V_{DRM} = 5V$ , $T_{case} = 25$ °C	350	mA
I <sub>GD</sub>	Gate non-trigger current	At 50% V <sub>DRM</sub> , T <sub>case</sub> = 125°C	10	mA

### **CURVES**

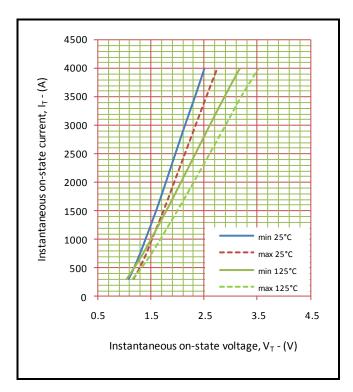


Fig.2 Maximum & minimum on-state characteristics

**V<sub>TM</sub> EQUATION** 

 $V_{TM} = A + Bln (I_T) + C.I_T + D.\sqrt{I_T}$ 

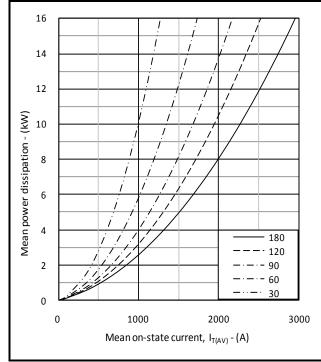
Where A = -0.069834

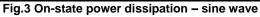
B = 0.220863

C = 0.000638

D = -0.013352

these values are valid for  $T_j = 125$ °C for  $I_T 300$ A to 4000A





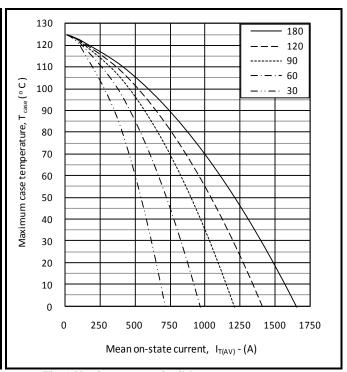


Fig.4 Maximum permissible case temperature, double side cooled – sine wave

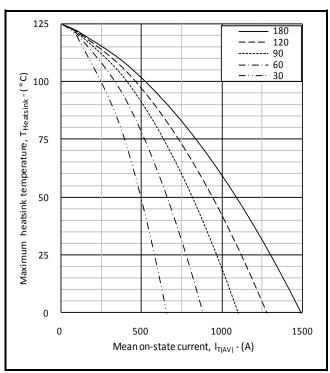


Fig.5 Maximum permissible heatsink temperature, double side cooled – sine wave

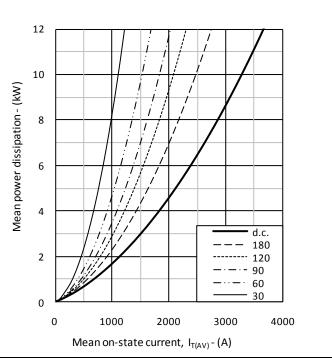


Fig.6 On-state power dissipation - rectangular wave

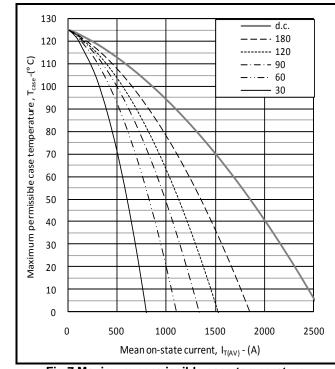


Fig.7 Maximum permissible case temperature, double side cooled – rectangular wave

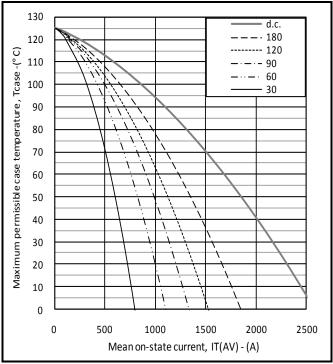
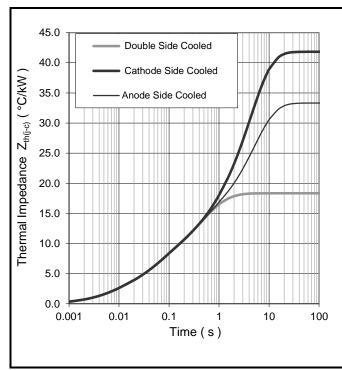


Fig.8 Maximum permissible heatsink temperature, double side cooled – rectangular wave



		1	2	3	4
Double side cooled	R <sub>i</sub> (°C/kW)	7.5608	4.0772	3.8420	2.8671
	T <sub>i</sub> (s)	0.6877	0.2537	0.0614	0.0101
Anode side cooled	R <sub>i</sub> (°C/kW)	6.7211	4.6219	15.5387	14.8631
	T <sub>i</sub> (s)	0.1910	0.0158	5.0011	3.3169
Cathode side cooled	R <sub>i</sub> (°C/kW)	11.5564	8.5810	4.7942	8.3643
	T <sub>i</sub> (s)	4.2216	6.0269	0.0166	0.2255

$$Z_{th} = \sum_{i=1}^{i=4} [R_i \times (1 - \exp(T/T_i))]$$

# $\Delta R_{th(j-c)}$ Conduction

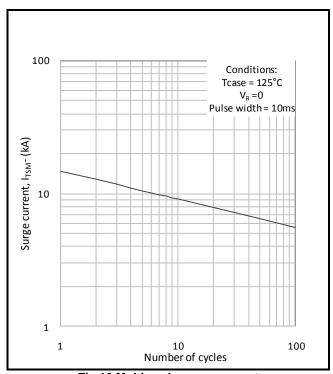
Tables show the increments of thermal resistance  $R_{\text{th}(j\text{-}c)}$  when the device operates at conduction angles other than d.c.

Double side cooling			ĺ	Anode Side Cooling			
	$\Delta Z_{th}$ (z)				$\Delta Z_t$	<sub>h</sub> (z)	
θ°	sine.	rect.	ĺ	θ°	sine.	rect.	
180	3.19	2.14	ĺ	180	2.97	2.03	
120	3.72	3.10	Ī	120	3.43	2.89	
90	4.29	3.64		90	3.92	3.36	
60	4.81	4.23	Ī	60	4.36	3.87	
30	5.22	4.88	[	30	4.69	4.41	
15	5.40	5.22	ĺ	15	4.84	4.70	

Fig.9 Maximum (limit) transient thermal impedance – junction to case (°C/kW)

athode Sided Cooling ΔZ<sub>th</sub> (z)

180





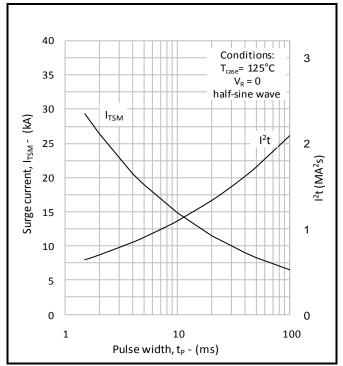


Fig.11 Single-cycle surge current

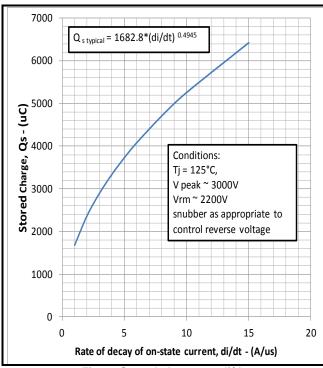


Fig.12 Stored charge vs di/dt

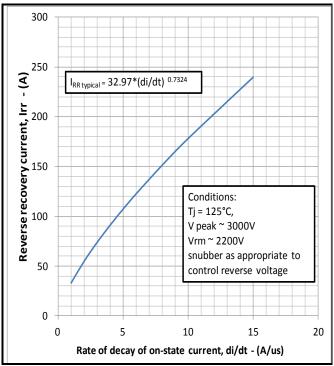


Fig.13 Reverse recovery current vs di/dt

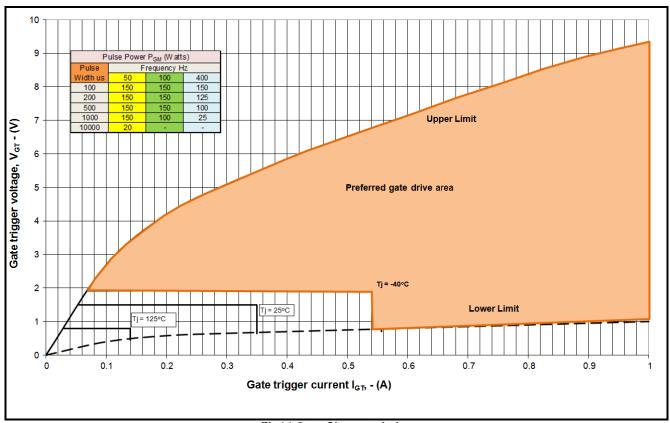


Fig14 Gate Characteristics

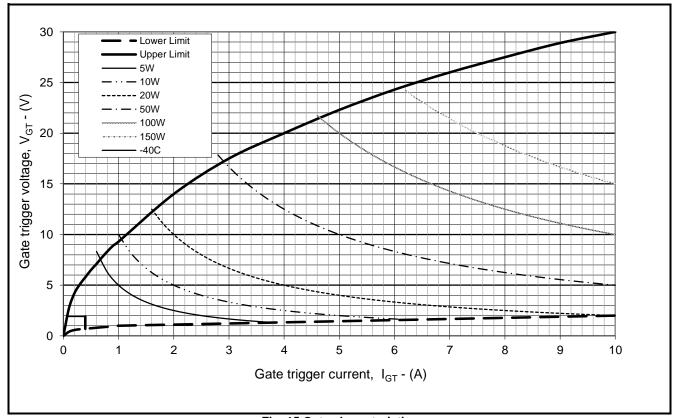


Fig. 15 Gate characteristics





### **PACKAGE DETAILS**

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.

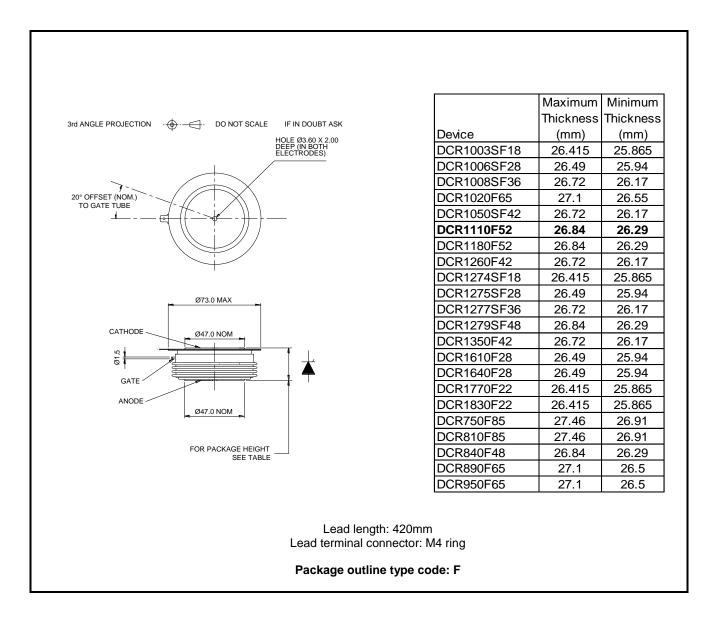


Fig.16 Package outline





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